VUSA003R240PA

Datasheet

General Description

$V_{(BR)DSS}$	$R_{DS(ON)\_max}$	I_D
-30V	24mΩ@-10V	-9.1A
	35mΩ@-4.5V	

Symbol

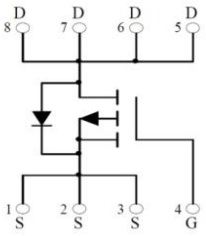
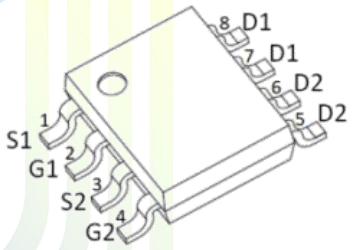


Figure 1 Symbol of VUSA003R240PA

Features

- Trench FET Power MOSFET
- Excellent $R_{DS(on)}$
- Low Gate Charge

Package Type



SOP8

Figure 2 Package Type of VUSA003R240PA

Application

- Load Switch for Portable Devices
- Battery Switch

Ordering Information

Product Name	Package
VUSA003R240PA	SOP8

Absolute Maximum Ratings (T_A= 25 ºC, unless otherwise specified)

Parameter	Symbol	Rating	Unit
Drain-Source Voltage	V_{DSS}	-30	V
Gate-Source Voltage	V_{GSS}	±20	V
Continuous Drain Current[Note1]	I_D	-9.1	A
Pulsed Drain Current [Note2]	I_{DM}	-27	
Total Power Dissipation[Note4]	P_D	1.4	W
Junction Temperature	T_J	150	ºC
Storage Temperature	T_{STG}	-55 to 150	ºC

Thermal Resistance

Parameter	Symbol	Min	Typ	Max	Unit
Thermal Resistance, Junction-to-Ambient[Note5]	$R_{\theta JA}$		89		ºC/W

Electrical Characteristics (T_J= 25 ºC, unless otherwise specified)

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Statistic Characteristics						
Drain-Source Breakdown Voltage	BV_{DSS}	V_{GS}=0V, I_D= 250uA	-30			V
Zero Gate Voltage Drain Current	I_{DSS}	V_{DS}= -30V, V_{GS}=0V			-1	uA
Gate-Body Leakage Current	I_{GSS}	V_{GS} = ±20V, V_{DS}= 0V			±100	nA
Gate Threshold Voltage[Note3]	$V_{GS(th)}$	V_{DS}=V_{GS}, I_D=-250uA	-1.0	-1.5	-3.0	V
Static Drain-Source On-Resistance[Note3]	$R_{DS(ON)}$	V_{GS}=-10V, I_D= -9.1A		18	24	mΩ
		V_{GS}=-4.5V, I_D= -6.9A		26	35	
Forward tranconductance[Note3]	g_{FS}	V_{DS}=-10V, I_D= -9.1A		12		S
Dynamic Characteristics						
Input Capacitance	C_{ISS}	V_{DS}=-15V		1400		pF
Output Capacitance	C_{OSS}	V_{GS}=0V		163		pF
Reverse Transfer Capacitance	C_{RSS}	f=1MHz		145		pF
Total Gate Charge	Q_g	V_{DS}=-15V			25	nC
Gate-Source Charge	Q_{gs}	V_{GS}=-4.5V			7	
Gate-Drain Charge	Q_{gd}	I_D= -9.1A			12	
Switching Parameters						
Turn-on Delay Time	$t_{d(on)}$	V_{DD}= -15V			15	ns
Turn-on Rise Time	t_r	V_{GS}= -10V			15	
Turn-off Delay Time	$t_{d(off)}$	I_D= -1A			70	
Turn-off Fall Time	t_f	R_G=1Ω, R_L=15Ω			25	
Diode Characteristics						
Diode Forward Voltage [Note3]	V_{SD}	V_{GS}=0V, I_S= -2A			-1.2	V
Diode Forward Current	I_S				-9.1	A
Pulsed Diode Forward Current	I_{SM}				-27	A

Notes :

1.The maximum current rating is limited by package.And device mounted on a large heatsink.

2.Pulse Test : Pulse Width ≤ 10μs, duty cycle ≤ 1%.

3.Pulse Test : Pulse Width ≤ 300μs, duty cycle ≤ 2%.

4.The power dissipation P_D is limited by $T_{J(MAX)}$ = 150°C.And device mounted on a large heatsink

5.Device mounted on 1in^2 FR-4 board with 2oz. Copper, in a still air environment with T_A =25°C.

Typical Performance Characteristics

Figure 3: Transfer Characteristics

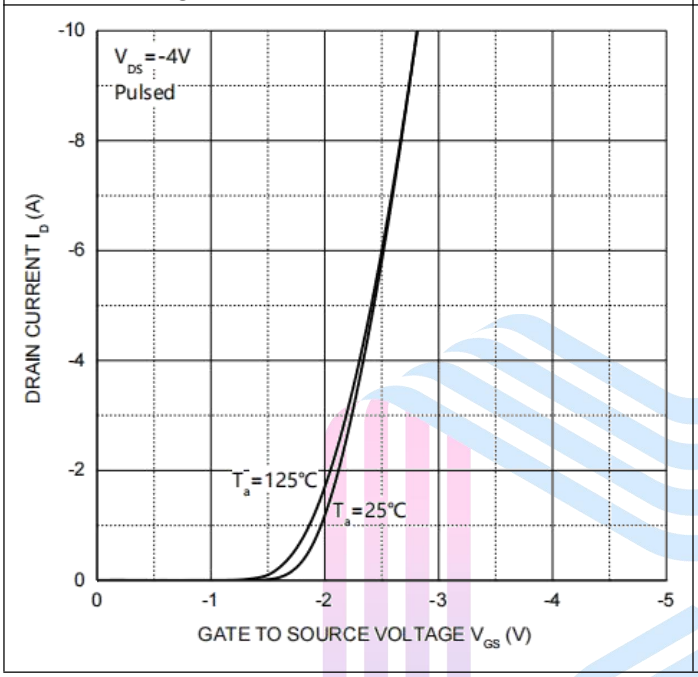


Figure 4: Output Characteristics

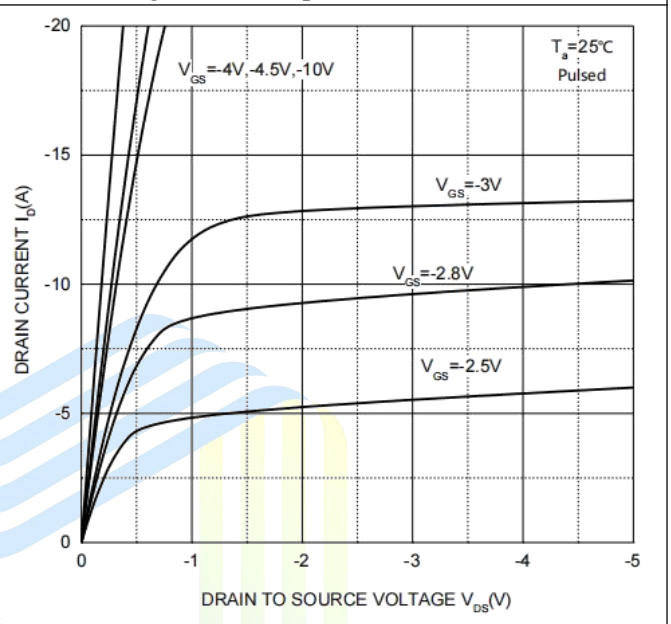


Figure 5: On-Resistance vs. Drain Current

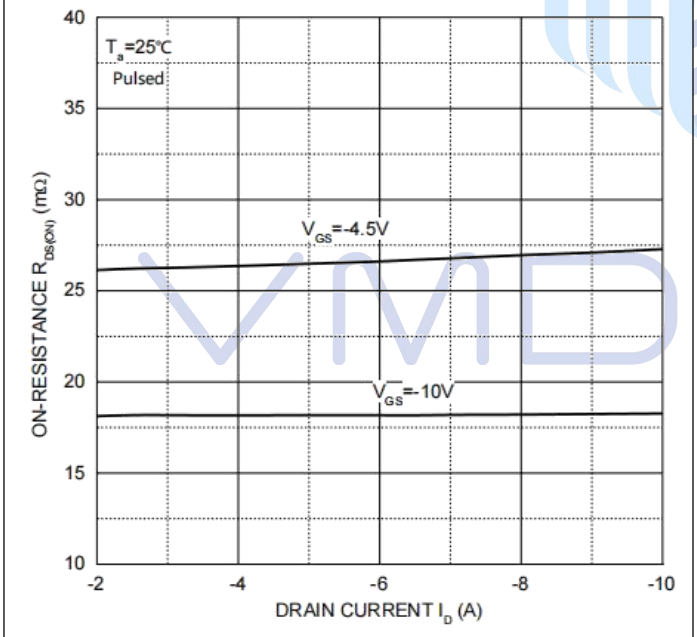


Figure 6: On-Resistance vs. Gate Voltage

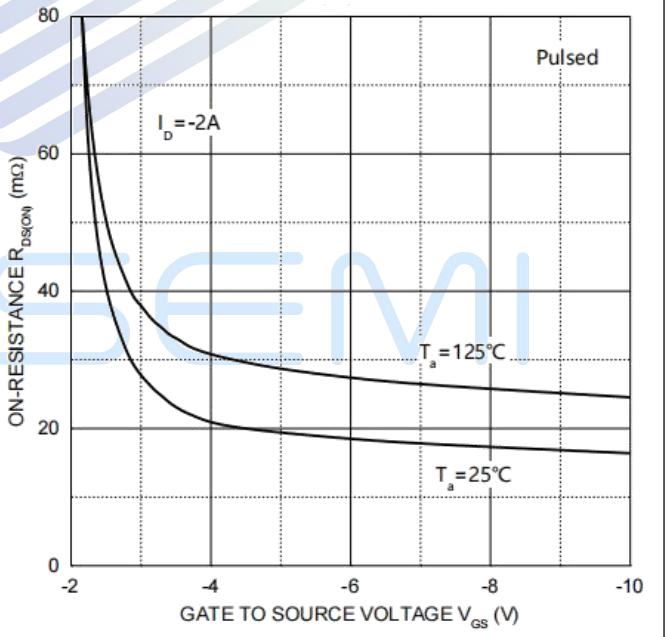


Figure 7: Body Diode Characteristics

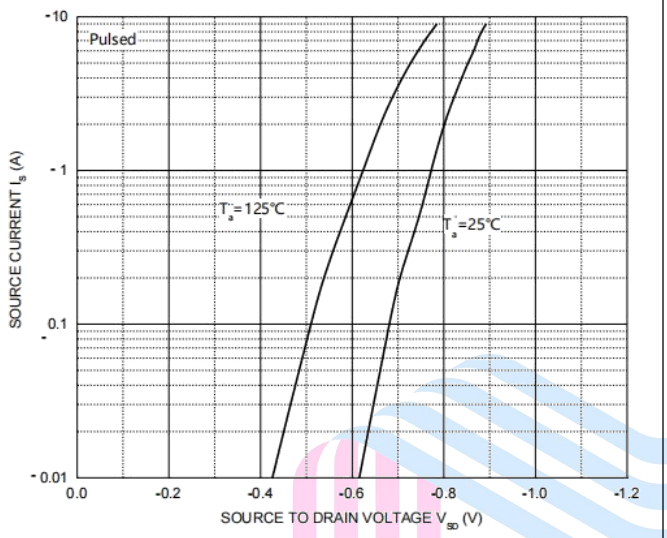
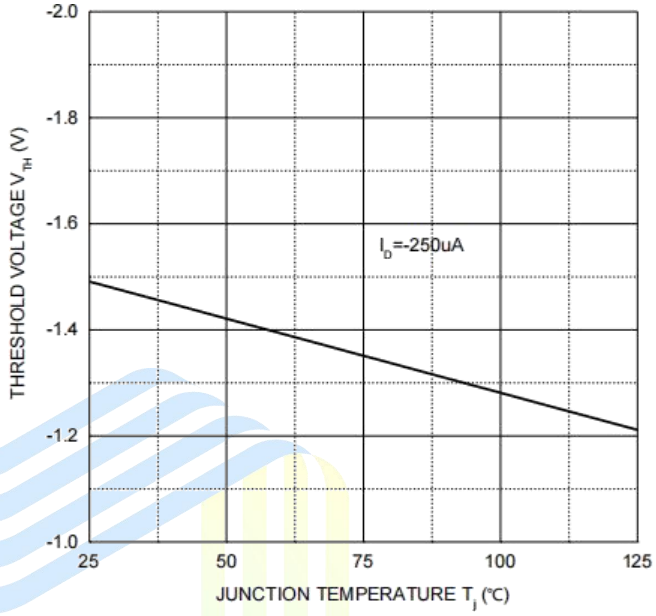
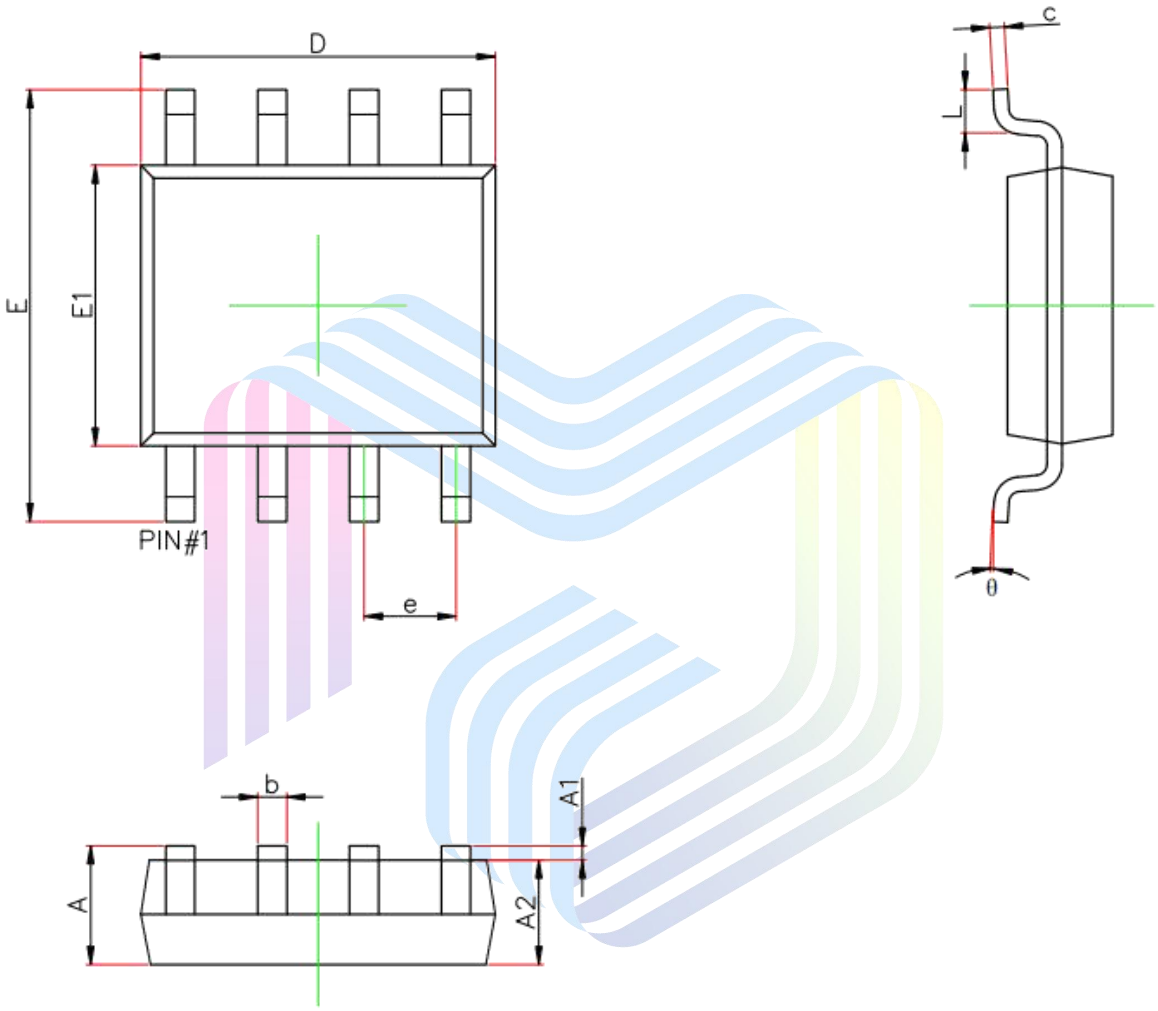


Figure 8: Threshold Voltage



Mechanical Dimensions:

SOP8 Package Information



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	1.350	1.750	0.053	0.069
A1	0.100	0.250	0.004	0.010
A2	1.350	1.550	0.053	0.061
b	0.330	0.510	0.013	0.020
c	0.156	0.250	0.006	0.010
D	4.700	5.100	0.185	0.201
e	1.270(BSC)		0.050(BSC)	
E	5.800	6.200	0.228	0.244
E1	3.700	4.100	0.146	0.161
L	0.400	1.270	0.016	0.05
θ	0°	8°	0°	8°

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